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- **Qualified for Automotive Applications**
- Operating Range 2-V to 5.5-V V<sub>CC</sub>
- Latch-Up Performance Exceeds 250 mA Per JESD 17

#### DW OR PW PACKAGE (TOP VIEW)

| OE1   | 1  | $\cup$ | 20 | ] ∨ <sub>cc</sub> |
|-------|----|--------|----|-------------------|
| A1 [  | 2  |        | 19 | OE2               |
| A2 [  | 3  |        | 18 | ] Y1              |
| A3 [  | 4  |        | 17 | ] Y2              |
| A4 [  | 5  |        | 16 | ] Y3              |
| A5 [  | 6  |        | 15 | ] Y4              |
| A6 [  | 7  |        | 14 | ] Y5              |
| A7 [  | 8  |        | 13 | ] Y6              |
| A8 [  | 9  |        | 12 | ] Y7              |
| GND [ | 10 |        | 11 | ] Y8              |
|       |    |        |    |                   |

#### description/ordering information

The SN74AHC541 octal buffer/driver is ideal for driving bus lines or buffer memory address registers. This device features inputs and outputs on opposite sides of the package to facilitate printed circuit board layout.

The 3-state control gate is a two-input AND gate with active-low inputs so that if either output-enable (OE1 or OE2) input is high, all corresponding outputs are in the high-impedance state. The outputs provide noninverted data when they are not in the high-impedance state.

To ensure the high-impedance state during power up or power down,  $\overline{\text{OE}}$  should be tied to  $V_{\text{CC}}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

#### ORDERING INFORMATION<sup>†</sup>

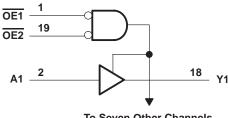
| TA             | PACKA      | GE <sup>‡</sup> | ORDERABLE<br>PART NUMBER | TOP-SIDE<br>MARKING |  |
|----------------|------------|-----------------|--------------------------|---------------------|--|
| -40°C to 125°C | SOIC - DW  | Tape and reel   | SN74AHC541QDWRQ1         | AHC541Q             |  |
| -40 C 10 125°C | TSSOP - PW | Tape and reel   | SN74AHC541QPWRQ1         | AHC541Q             |  |

<sup>†</sup> For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at http://www.ti.com.

#### **FUNCTION TABLE** (each buffer/driver)

|     | INPUTS |   |   |  |  |  |  |  |  |  |  |
|-----|--------|---|---|--|--|--|--|--|--|--|--|
| OE1 | OE2    | Α | Y |  |  |  |  |  |  |  |  |
| L   | L      | L | L |  |  |  |  |  |  |  |  |
| L   | L      | Н | Н |  |  |  |  |  |  |  |  |
| Н   | X      | Χ | Z |  |  |  |  |  |  |  |  |
| Х   | Н      | Χ | Z |  |  |  |  |  |  |  |  |

#### logic diagram (positive logic)



To Seven Other Channels



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



<sup>‡</sup> Package drawings, thermal data, and symbolization are available at http://www.ti.com/packaging.

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## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

| Supply voltage range, V <sub>CC</sub>                               | –0.5 V to 7 V                              |
|---------------------------------------------------------------------|--------------------------------------------|
| Input voltage range, V <sub>I</sub> (see Note 1)                    | $-0.5$ V to 7 V                            |
| Output voltage range, V <sub>O</sub> (see Note 1)                   | $-0.5 \text{ V to V}_{CC} + 0.5 \text{ V}$ |
| Input clamp current, $I_{IK}$ ( $V_I < 0$ )                         | –20 mA                                     |
| Output clamp current, $I_{OK}$ ( $V_O < 0$ or $V_O > V_{CC}$ )      | ±20 mA                                     |
| Continuous output current, $I_O$ ( $V_O = 0$ to $V_{CC}$ )          |                                            |
| Continuous current through V <sub>CC</sub> or GND                   | ±75 mA                                     |
| Package thermal impedance, θ <sub>JA</sub> (see Note 2): DW package | 58°C/W                                     |
| PW package                                                          | 83°C/W                                     |
| Storage temperature range, T <sub>eta</sub>                         | 65°C to 150°C                              |

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

### recommended operating conditions (see Note 3)

|          |                                        |                                            | MIN  | MAX  | UNIT |
|----------|----------------------------------------|--------------------------------------------|------|------|------|
| Vcc      | Supply voltage                         |                                            | 2    | 5.5  | V    |
|          |                                        | V <sub>CC</sub> = 2 V                      | 1.5  |      |      |
| $V_{IH}$ | High-level input voltage               | V <sub>CC</sub> = 3 V                      | 2.1  |      | V    |
|          |                                        | V <sub>CC</sub> = 5.5 V                    | 3.85 |      |      |
|          |                                        | V <sub>CC</sub> = 2 V                      |      | 0.5  |      |
| $V_{IL}$ | Low-level input voltage                | V <sub>CC</sub> = 3 V                      |      | 0.9  | V    |
|          |                                        | V <sub>CC</sub> = 5.5 V                    |      | 1.65 |      |
| VI       | Input voltage                          |                                            | 0    | 5.5  | V    |
| ٧o       | Output voltage                         |                                            | 0    | VCC  | V    |
|          |                                        | V <sub>CC</sub> = 2 V                      |      | -50  | μΑ   |
| loh      | High-level output current              | $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ |      | -4   | A    |
|          |                                        | $V_{CC} = 5 V \pm 0.5 V$                   |      | -8   | mA   |
|          |                                        | V <sub>CC</sub> = 2 V                      |      | 50   | μΑ   |
| loL      | Low-level output current               | $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ |      | 4    |      |
|          |                                        | $V_{CC} = 5 V \pm 0.5 V$                   |      | 8    | mA   |
| A4/A     | lands the continue with a content mate | $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ |      | 100  |      |
| Δt/Δv    | Input transition rise or fall rate     | $V_{CC} = 5 V \pm 0.5 V$                   |      | 20   | ns/V |
| TA       | Operating free-air temperature         |                                            | -40  | 125  | °C   |

NOTE 3: All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

<sup>2.</sup> The package thermal impedance is calculated in accordance with JESD 51-7.

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER         | TEST CONDITIONS                                                      | VCC          | T <sub>A</sub> = 25°C |     |       | T <sub>A</sub> = - |      | T <sub>A</sub> = -40°C<br>TO 85°C |      | UNIT |
|-------------------|----------------------------------------------------------------------|--------------|-----------------------|-----|-------|--------------------|------|-----------------------------------|------|------|
|                   |                                                                      |              | MIN                   | TYP | MAX   | MIN                | MAX  | MIN                               | MAX  |      |
|                   |                                                                      | 2 V          | 1.9                   | 2   |       | 1.9                |      | 1.9                               |      |      |
|                   | I <sub>OH</sub> = -50 μA                                             | 3 V          | 2.9                   | 3   |       | 2.9                |      | 2.9                               |      |      |
| Voн               |                                                                      | 4.5 V        | 4.4                   | 4.5 |       | 4.4                |      | 4.4                               |      | V    |
|                   | $I_{OH} = -4 \text{ mA}$                                             | 3 V          | 2.58                  |     |       | 2.48               |      | 2.48                              |      |      |
|                   | I <sub>OH</sub> = -8 mA                                              | 4.5 V        | 3.94                  |     |       | 3.8                |      | 3.8                               |      |      |
|                   |                                                                      | 2 V          |                       |     | 0.1   |                    | 0.1  |                                   | 0.1  |      |
|                   | I <sub>OL</sub> = 50 μA                                              | 3 V          |                       |     | 0.1   |                    | 0.1  |                                   | 0.1  |      |
| VOL               |                                                                      | 4.5 V        |                       |     | 0.1   |                    | 0.1  |                                   | 0.1  | V    |
|                   | I <sub>OL</sub> = 4 mA                                               | 3 V          |                       |     | 0.36  |                    | 0.5  |                                   | 0.44 |      |
|                   | I <sub>OL</sub> = 8 mA                                               | 4.5 V        |                       |     | 0.36  |                    | 0.5  |                                   | 0.44 |      |
| I <sub>I</sub>    | V <sub>I</sub> = 5.5 V or GND                                        | 0 V to 5.5 V |                       |     | ±0.1  |                    | ±1   |                                   | ±1   | μΑ   |
| l <sub>OZ</sub> † | $V_O = V_{CC}$ or GND,<br>$V_I (\overline{OE}) = V_{IL}$ or $V_{IH}$ | 5.5 V        |                       |     | ±0.25 |                    | ±2.5 |                                   | ±2.5 | μΑ   |
| Icc               | $V_I = V_{CC}$ or GND, $I_O = 0$                                     | 5.5 V        |                       |     | 4     |                    | 40   |                                   | 40   | μΑ   |
| Ci                | $V_I = V_{CC}$ or GND                                                | 5 V          |                       | 2   | 10    |                    |      |                                   | 10   | pF   |
| Co                | $V_O = V_{CC}$ or GND                                                | 5 V          |                       | 4   |       |                    | ·    |                                   |      | pF   |

<sup>†</sup> For input and ouput, IOZ includes the input leakage current.

# switching characteristics over recommended operating free-air temperature range, $V_{CC}$ = 3.3 V $\pm$ 0.3 V (unless otherwise noted) (see Figure 1)

| PARAMETER        | FROM<br>(INPUT) | TO<br>(OUTPUT) | LOAD<br>CAPACITANCE    | T,         | 4 = 25°C   | ;                       | T <sub>A</sub> = - |      | T <sub>A</sub> = - |      | UNIT |   |    |    |
|------------------|-----------------|----------------|------------------------|------------|------------|-------------------------|--------------------|------|--------------------|------|------|---|----|----|
|                  | (INFOT)         | (001F01)       | CAFACITANCE            | MIN        | TYP        | MAX                     | MIN                | MAX  | MIN                | MAX  |      |   |    |    |
| t <sub>PLH</sub> | ^               | Y              | 0. 45.5                |            | 5          | 7                       | 1                  | 8.5  | 1                  | 8.5  |      |   |    |    |
| t <sub>PHL</sub> | Α               | Y              | C <sub>L</sub> = 15 pF |            | 5          | 7                       | 1                  | 8.5  | 1                  | 8.5  | ns   |   |    |    |
| <sup>t</sup> PZH | ŌĒ              | V              | 0 455                  |            | 6          | 10.5                    | 1                  | 11   | 1                  | 11   |      |   |    |    |
| tPZL             | OE              | Y              | C <sub>L</sub> = 15 pF |            | 6          | 10.5                    | 1                  | 11   | 1                  | 11   | ns   |   |    |    |
| tPHZ             | ŌĒ              | Y              | 0 45 -5                |            | 7          | 11                      | 1                  | 12   | 1                  | 12   |      |   |    |    |
| tPLZ             | OE              | Y              | C <sub>L</sub> = 15 pF |            | 7          | 11                      | 1                  | 12   | 1                  | 12   | ns   |   |    |    |
| tPLH             | ^               | Y              | 0. 50.55               |            | 7.5        | 10.5                    | 1                  | 12   | 1                  | 12   |      |   |    |    |
| <sup>t</sup> PHL | Α               | Y              | CL = 50 pr             | CL = 50 pr | CL = 50 pr | Y $C_L = 50 \text{ pF}$ |                    | 7.5  | 10.5               | 1    | 12   | 1 | 12 | ns |
| <sup>t</sup> PZH | ŌĒ              | V              | 0. 50.55               |            | 8          | 14                      | 1                  | 16   | 1                  | 16   |      |   |    |    |
| t <sub>PZL</sub> | OE              | Y              | C <sub>L</sub> = 50 pF |            | 8          | 14                      | 1                  | 16   | 1                  | 16   | ns   |   |    |    |
| t <sub>PHZ</sub> | ŌĒ              |                | 0 50 5                 |            | 9          | 15.4                    | 1                  | 17.5 | 1                  | 17.5 |      |   |    |    |
| tPLZ             | OE              | Υ              | C <sub>L</sub> = 50 pF |            | 9          | 15.4                    | 1                  | 17.5 | 1                  | 17.5 | ns   |   |    |    |
| tsk(o)           |                 |                | C <sub>L</sub> = 50 pF | ·          |            | 1.5                     |                    |      | ·                  | 1.5  | ns   |   |    |    |



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# switching characteristics over recommended operating free-air temperature range, $V_{CC}$ = 5 V $\pm$ 0.5 V (unless otherwise noted) (see Figure 1)

| PARAMETER        | FROM<br>(INPUT) | TO<br>(OUTPUT) | LOAD<br>CAPACITANCE      | T,  | <b>Վ = 25°</b> C | ;   | T <sub>A</sub> = - |      | T <sub>A</sub> = -40°C<br>TO 85°C |      | UNIT |
|------------------|-----------------|----------------|--------------------------|-----|------------------|-----|--------------------|------|-----------------------------------|------|------|
|                  | (INFOT)         | (001-01)       | CAFACITANCE              | MIN | TYP              | MAX | MIN                | MAX  | MIN                               | MAX  |      |
| <sup>t</sup> PLH | ^               | Y              | 0 45 5                   |     | 3.5              | 5   | 1                  | 6    | 1                                 | 6    |      |
| t <sub>PHL</sub> | Α               | Y              | C <sub>L</sub> = 15 pF   |     | 3.5              | 5   | 1                  | 6    | 1                                 | 6    | ns   |
| <sup>t</sup> PZH | ŌĒ              | Y              | 0. 45.5                  |     | 4.7              | 7.2 | 1                  | 8.5  | 1                                 | 8.5  |      |
| tPZL             | OE              | Y              | C <sub>L</sub> = 15 pF   |     | 4.7              | 7.2 | 1                  | 8.5  | 1                                 | 8.5  | ns   |
| <sup>t</sup> PHZ | <u>OE</u>       | Υ              | 0. 45.5                  |     | 5                | 7.5 | 1                  | 8    | 1                                 | 8    |      |
| t <sub>PLZ</sub> | OE              | Y              | C <sub>L</sub> = 15 pF   |     | 5                | 7.5 | 1                  | 8    | 1                                 | 8    | ns   |
| <sup>t</sup> PLH | •               | Y              | C <sub>L</sub> = 50 pF   |     | 5                | 7   | 1                  | 8    | 1                                 | 8    |      |
| <sup>t</sup> PHL | Α               | Y              |                          |     | 5                | 7   | 1                  | 8    | 1                                 | 8    | ns   |
| <sup>t</sup> PZH | <u>OE</u>       | Y              | 0 50 5                   |     | 6.2              | 9.2 | 1                  | 10.5 | 1                                 | 10.5 |      |
| t <sub>PZL</sub> | OE              | Y              | $C_L = 50 pF$            |     | 6.2              | 9.2 | 1                  | 10.5 | 1                                 | 10.5 | ns   |
| <sup>t</sup> PHZ | ŌĒ Y            |                | Y C <sub>I</sub> = 50 pF |     | 6                | 8.8 | 1                  | 10   | 1                                 | 10   | ns   |
| t <sub>PLZ</sub> | OE .            | ľ              | GL = 50 pr               |     | 6                | 8.8 | 1                  | 10   | 1                                 | 10   | 115  |
| tsk(o)           |                 |                | C <sub>L</sub> = 50 pF   |     |                  | 1   |                    |      |                                   | 1    | ns   |

## noise characteristics, $V_{CC}$ = 5 V, $C_L$ = 50 pF, $T_A$ = 25°C (see Note 4)

|                    | PARAMETER                                     | MIN | MAX  | UNIT |
|--------------------|-----------------------------------------------|-----|------|------|
| V <sub>OL(P)</sub> | Quiet output, maximum dynamic V <sub>OL</sub> |     | 0.8  | V    |
| V <sub>OL(V)</sub> | Quiet output, minimum dynamic V <sub>OL</sub> |     | -0.8 | V    |
| VOH(V)             | Quiet output, minimum dynamic VOH             | 4.7 |      | V    |
| VIH(D)             | High-level dynamic input voltage              | 3.5 |      | V    |
| V <sub>IL(D)</sub> | Low-level dynamic input voltage               |     | 1.5  | V    |

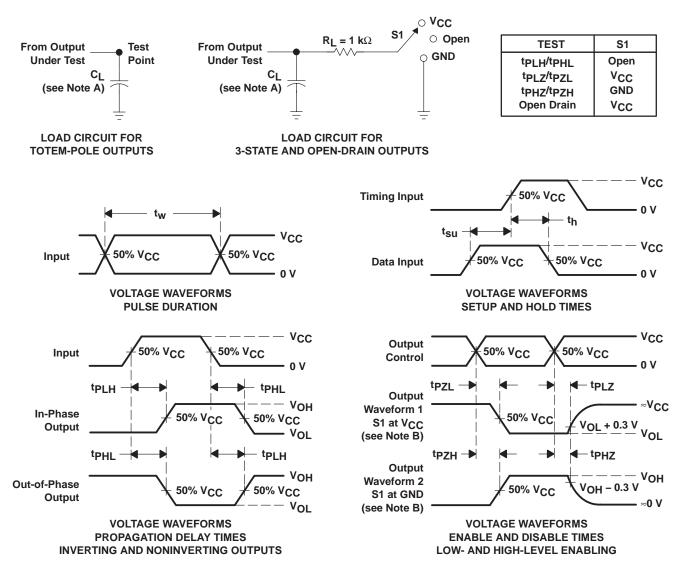
NOTE 4: Characteristics are for surface-mount packages only.

## operating characteristics, $V_{CC} = 5 \text{ V}$ , $T_A = 25^{\circ}\text{C}$

|                 | PARAMETER                     | TEST C   | ONDITIONS | TYP | UNIT |
|-----------------|-------------------------------|----------|-----------|-----|------|
| C <sub>pd</sub> | Power dissipation capacitance | No load, | f = 1 MHz | 12  | pF   |



#### PARAMETER MEASUREMENT INFORMATION



NOTES: A.  $C_L$  includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  1 MHz,  $Z_O = 50 \Omega$ ,  $t_f \leq 3$  ns.  $t_f \leq 3$  ns.
- D. The outputs are measured one at a time, with one input transition per measurement.
- E. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms







11-Apr-2013

#### **PACKAGING INFORMATION**

|   | Orderable Device         |        | Package Type | Package<br>Drawing | Pins | Package<br>Qty |                            | Lead/Ball Finish | MSL Peak Temp      | Op Temp (°C) | Top-Side Markings | Samples |
|---|--------------------------|--------|--------------|--------------------|------|----------------|----------------------------|------------------|--------------------|--------------|-------------------|---------|
| - | 01/2441/05440/07/1/05404 | (1)    | T000D        | - J                |      |                | (2)                        | OLI NUDDALI      | (3)                | 40 / 405     | (4)               |         |
|   | SN74AHC541QPWRG4Q1       | ACTIVE | TSSOP        | PW                 | 20   | 2000           | Green (RoHS & no Sb/Br)    | CU NIPDAU        | Level-1-260C-UNLIM | -40 to 125   | AHC541Q           | Samples |
|   | SN74AHC541QPWRQ1         | ACTIVE | TSSOP        | PW                 | 20   | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | -40 to 125   | AHC541Q           | Samples |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) Multiple Top-Side Markings will be inside parentheses. Only one Top-Side Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Top-Side Marking for that device.

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#### OTHER QUALIFIED VERSIONS OF SN74AHC541-Q1:



## **PACKAGE OPTION ADDENDUM**

11-Apr-2013

• Catalog: SN74AHC541

Military: SN54AHC541

NOTE: Qualified Version Definitions:

• Catalog - TI's standard catalog product

• Military - QML certified for Military and Defense Applications

## PACKAGE MATERIALS INFORMATION

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### TAPE AND REEL INFORMATION





|    | Dimension designed to accommodate the component width     |
|----|-----------------------------------------------------------|
| В0 | Dimension designed to accommodate the component length    |
| K0 | Dimension designed to accommodate the component thickness |
| W  | Overall width of the carrier tape                         |
| P1 | Pitch between successive cavity centers                   |

### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

| Device                 | Package<br>Type | Package<br>Drawing |    | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
|------------------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| SN74AHC541QPWRG4Q<br>1 | TSSOP           | PW                 | 20 | 2000 | 330.0                    | 16.4                     | 6.95       | 7.1        | 1.6        | 8.0        | 16.0      | Q1               |
| SN74AHC541QPWRQ1       | TSSOP           | PW                 | 20 | 2000 | 330.0                    | 16.4                     | 6.95       | 7.1        | 1.6        | 8.0        | 16.0      | Q1               |

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#### \*All dimensions are nominal

| Device             | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|--------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74AHC541QPWRG4Q1 | TSSOP        | PW              | 20   | 2000 | 367.0       | 367.0      | 38.0        |
| SN74AHC541QPWRQ1   | TSSOP        | PW              | 20   | 2000 | 367.0       | 367.0      | 38.0        |

PW (R-PDSO-G20)

## PLASTIC SMALL OUTLINE



NOTES:

- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M—1994.
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0,15 each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0,25 each side.
- E. Falls within JEDEC MO-153



## PW (R-PDSO-G20)

## PLASTIC SMALL OUTLINE



NOTES:

- All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
  C. Publication IPC-7351 is recommended for alternate design.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



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